

Chip Beads(SMD) For Power Line

Conformity to RoHS Directive

MPZ Series MPZ1608 Type

FEATURES

- This type is the best for energy-saving in the low DC resistance.
- The products contain no lead and also support lead-free soldering.
- It is a product conforming to RoHS directive.

APPLICATIONS

Removal of power line noises of cellular phones, PCs, note PCs, TVs, TV tuners, STBs, audio players, DVDs, DSCs, DVCs, game machines, digital photo frames, car navigation system, PNDs, etc.

PRODUCT IDENTIFICATION

MPZ	1608	S	221	A	T
(1)	(2)	(3)	(4)	(5)	(6)

- (1) Series name
- (2) Dimensions L×W
- (3) Material code
- (4) Nominal impedance
221: 220Ω at 100MHz
- (5) Characteristic type
- (6) Packaging style
T: Taping

HANDLING AND PRECAUTIONS

- Before soldering, be sure to preheat components. The preheating temperature should be set so that the temperature difference between the solder temperature and product temperature does not exceed 150°C.
- After mounting components onto the printed circuit board, do not apply stress through board bending or mishandling.
- Do not expose the inductors to stray magnetic fields.
- Avoid static electricity discharge during handling.
- When hand soldering, apply the soldering iron to the printed circuit board only. Temperature of the iron tip should not exceed 350°C. Soldering time should not exceed 3 seconds.

MATERIAL CHARACTERISTICS

B material: This type is perfectly suited for fast digital signals. By equalizing R components and X components that beads possess at a frequency of 5MHz, it is able to suppress overshooting, undershooting and ringing of fast digital signals.

R material: For wide frequency applications calling for broad impedance characteristics.

For digital signal line applications calling requiring good waveform integrity. Impedance values selected for effectiveness at 10 to 200MHz.

S material: Standard type that features impedance characteristics similar to those of a typical ferrite core.

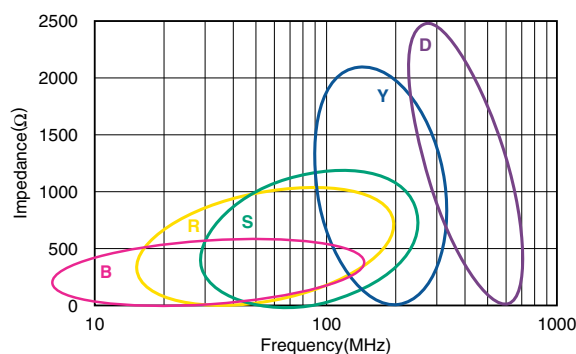
For signal line applications in which the blocking region is near 100MHz. Impedance values selected for effectiveness at 40 to 300MHz.

Y material: High frequency range type intended for the 100MHz region and above.

For signal line applications in which the signal frequency is far from the cutoff frequency. Impedance values selected for effectiveness at 80 to 400MHz.

D material: For applications calling for low insertion loss at low frequencies and sharply increasing impedance at high frequencies. Designed for high impedance at high frequencies (300MHz to 1GHz) for signal line applications.

TYPICAL MATERIAL CHARACTERISTICS

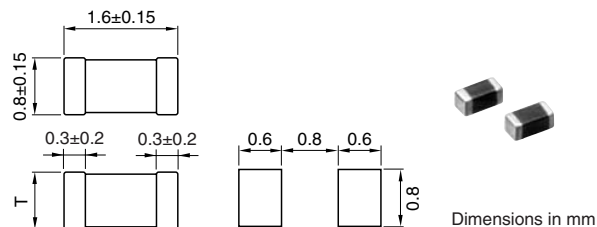


• Conformity to RoHS Directive: This means that, in conformity with EU Directive 2002/95/EC, lead, cadmium, mercury, hexavalent chromium, and specific bromine-based flame retardants, PBB and PBDE, have not been used, except for exempted applications.

• Please contact our Sales office when your application are considered the following:
The device's failure or malfunction may directly endanger human life (e.g. application for automobile/aircraft/medical/nuclear power devices, etc.)

• All specifications are subject to change without notice.

SHAPES AND DIMENSIONS/RECOMMENDED PC BOARD PATTERN



Thickness(T)	Weight
0.6±0.15mm	3mg
0.8±0.15mm	4mg

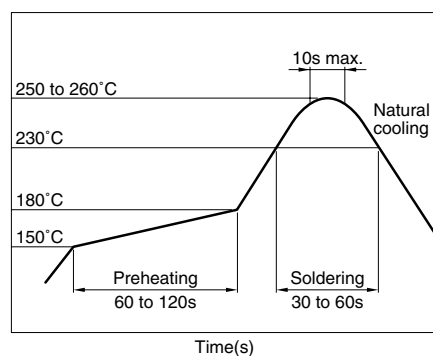
TEMPERATURE RANGES

Operating/storage	-55 to +125°C
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PACKAGING STYLE AND QUANTITIES

Packaging style	Quantity
Taping	4000 pieces/reel

RECOMMENDED SOLDERING CONDITION REFLOW SOLDERING



ELECTRICAL CHARACTERISTICS

Part No.	Impedance (Ω)[100MHz] ^{*1}	DC resistance (Ω)max.	Rated current ^{*2} (A)max.	Thickness T(mm)
MPZ1608B471A	470±25%	0.150	1.0	0.8
MPZ1608S300A	30±10 Ω	0.010	5.0	0.6
MPZ1608S600A	60±25%	0.020	3.5	0.6
MPZ1608S101A	100±25%	0.030	3.0	0.6
MPZ1608S121A	120±25%	0.045	2.0	0.6
MPZ1608S181A	180±25%	0.050	2.0	0.6
MPZ1608S221A	220±25%	0.050	2.2	0.8
MPZ1608S331A	330±25%	0.080	1.7	0.8
MPZ1608R391A	390±25%	0.120	1.2	0.8
MPZ1608S471A	470±25%	0.150	1.0	0.8
MPZ1608S601A	600±25%	0.150	1.0	0.8
MPZ1608S102A	1000±25%	0.300	0.8	0.8
MPZ1608Y600B	60±25%	0.030	2.3	0.8
MPZ1608Y101B	100±25%	0.040	2.0	0.8
MPZ1608Y151B	150±25%	0.050	1.8	0.8
MPZ1608Y221B	220±25%	0.100	1.5	0.8
MPZ1608D300B	30±10 Ω	0.060	1.8	0.8
MPZ1608D600B	60±25%	0.100	1.2	0.8
MPZ1608D101B	100±25%	0.150	1.0	0.8

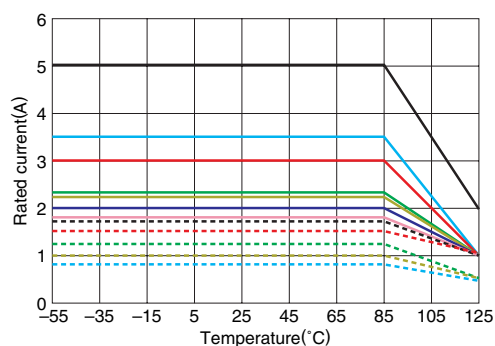
*1 Test equipment: E4991A or equivalent

Test tool: 16192A or equivalent

Test temperature: 25±10°C

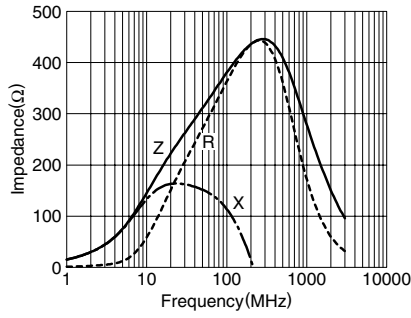
*2 Please refer to the graph of RATED CURRENT vs. TEMPERATURE CHARACTERISTICS(DERATING) about the rating current at 85°C or more in temperature of the product.

RATED CURRENT vs. TEMPERATURE CHARACTERISTICS (DERATING)

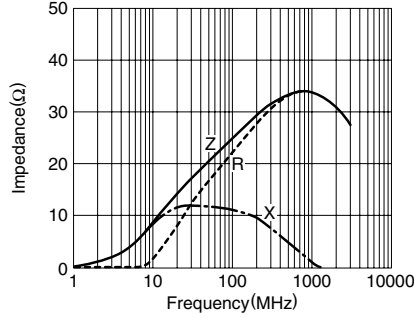


TYPICAL ELECTRICAL CHARACTERISTICS
Z, X, R vs. FREQUENCY CHARACTERISTICS

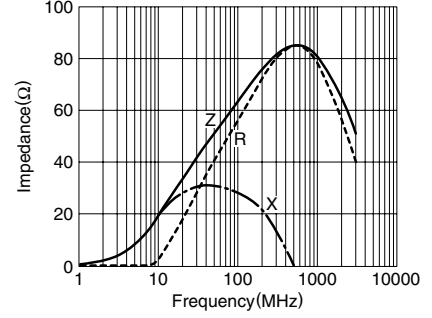
MPZ1608B121C



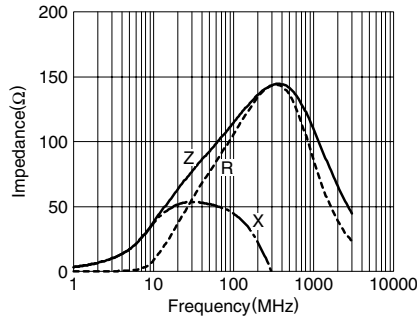
MPZ1608S300A



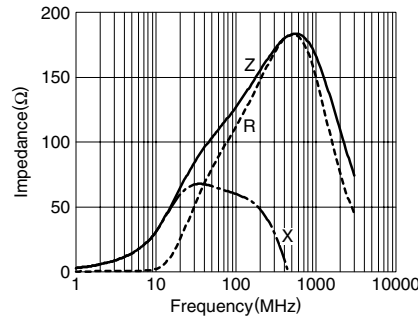
MPZ1608S600A



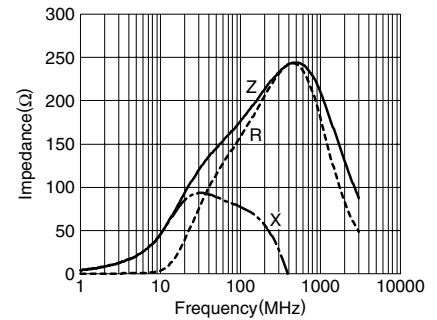
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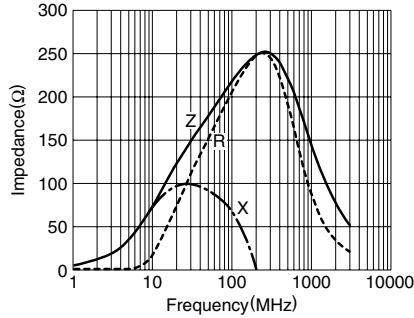
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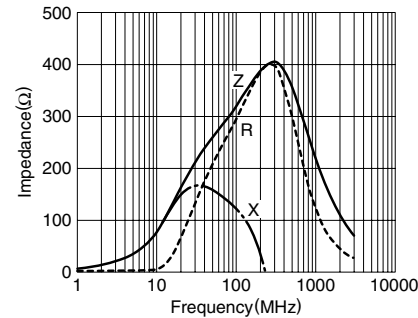
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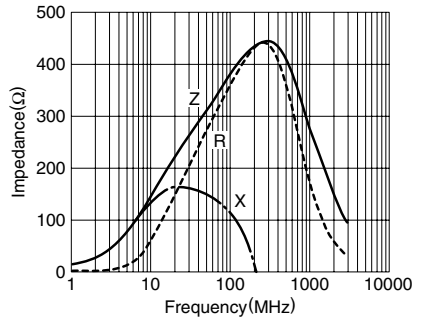
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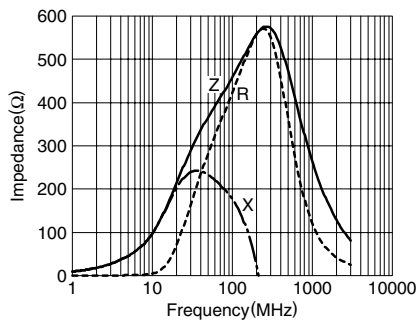
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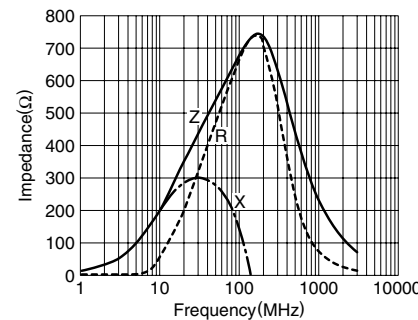
MPZ1608R391A



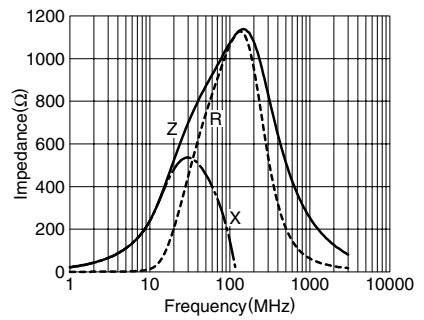
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MPZ1608S601A



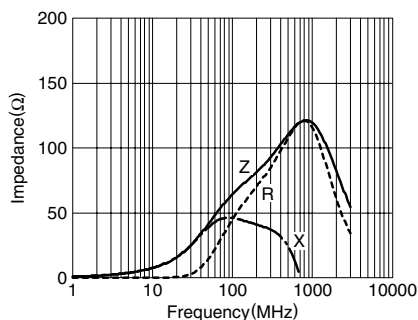
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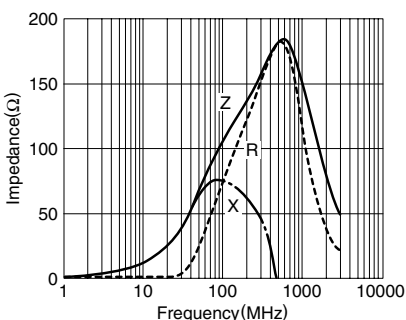
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TYPICAL ELECTRICAL CHARACTERISTICS Z, X, R vs. FREQUENCY CHARACTERISTICS

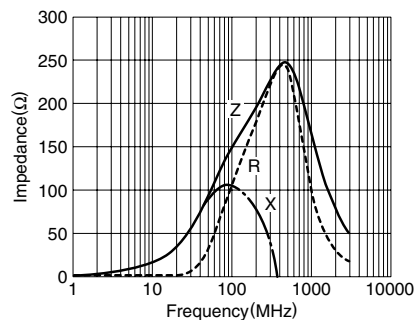
MPZ1608Y600B



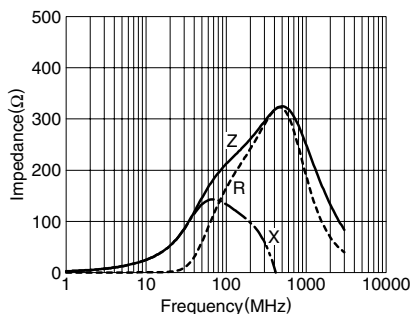
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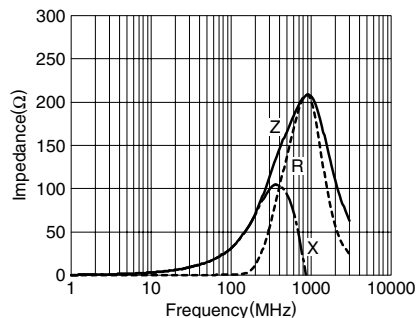
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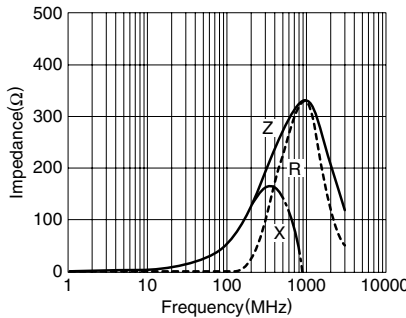
MPZ1608Y221B



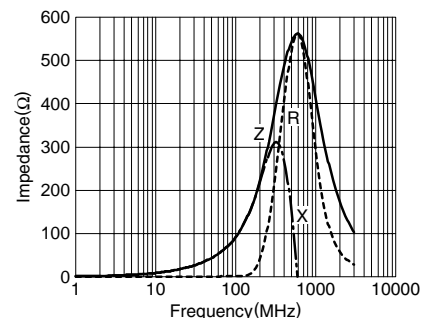
MPZ1608D300B



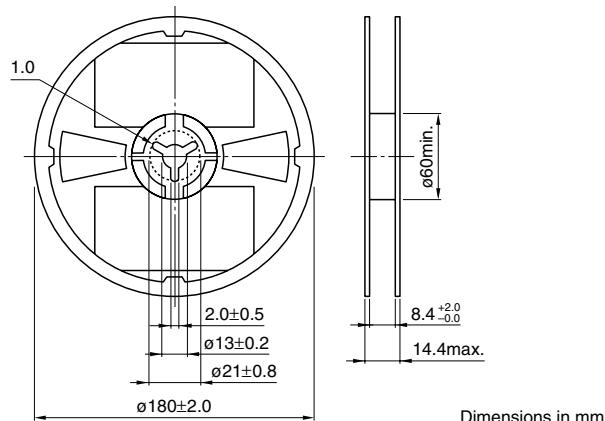
MPZ1608D600B



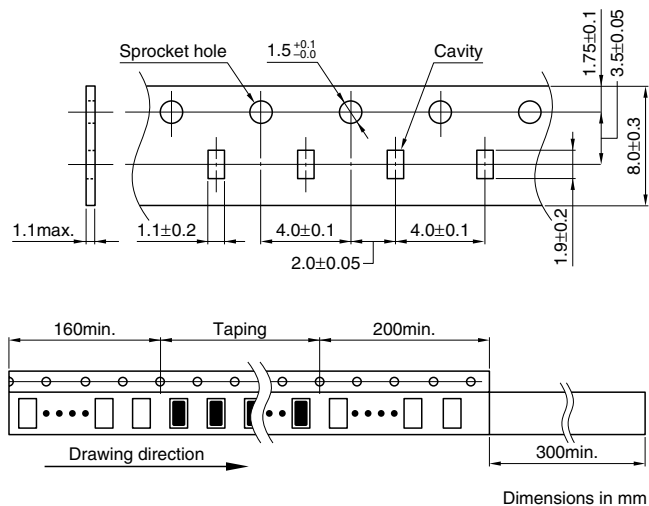
MPZ1608D101B



PACKAGING STYLES REEL DIMENSIONS



TAPE DIMENSIONS



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